

L Number	Hits	Search Text	DB	Time stamp
1	9693	324/754-765.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/06/12 09:13
2	391	(electrode adj1 pad) and (wiring adj board) and bonded	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2004/06/12 09:15
3	18	324/754-765.ccls. and ((electrode adj1 pad) and (wiring adj board) and bonded)	US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/12 09:15